SMT International, LLC
SAFETY DATA SHEET (SDS)

SECTION 1: PRODUCT AND COMPANY IDENTIFICATION

PRODUCT NAME: Amtech Lead Free Solder Paste SynTECH Series Sno SMDSNL (series lead free paste)
SYNONYMS: Paste, Solder Cream
MANUFACTURER: SMT International, LLC MANUFACTURED FOR CHIP QUIK, INC
ADDRESS: PO Box 989 Deep River, CT 06417 USA
PHONE: 860-526-8300
FAX: 860-526-8243
EMERGENCY: Infotrac-(800)535-5035
REVISION DATE: March 13, 2014
REVISION NUMBER: 2
DOCUMENT NAME: SDS-Paste-004
PRODUCT USE: Soldering components for bonding semiconductor chips and packages to circuit boards

SECTION 2: HAZARDS IDENTIFICATION

CHEMICAL NAME: N/A
CHEMICAL FAMILY: Mixture
CHEMICAL FORMULA: Proprietary

ROUTES OF ENTRY: Inhalation, Ingestion, Skin/Eye Contact

GHS:

Signal Word: Warning

Hazard Statement(s)
H302 Harmful if swallowed
H316 Causes mild skin irritation
H333 May be harmful if inhaled
H335 May cause respiratory irritation
H336 May cause drowsiness or dizziness

Precautionary Statement(s)
P102 Keep out of reach of children
P233 Keep container tightly closed
P261 Avoid breathing dust/fume/gas/mist/vapors/spray
P270 Do not eat, drink, or smoke when using this product
P280 Wear protective gloves/protective eye protection/face protection
P235 + P402 Keep cool. Store in a dry place.
P301 + P310 IF SWALLOWED: Immediately call a POISON CENTER or doctor/physician
P302 + P352 IF ON SKIN: Wash with plenty of soap and water
P304 + P340 IF IN EYES: Rinse continuously with water for several minutes
P305 + P351 IF IN EYES: Rinse continuously with water for several minutes

MEDICAL CONDITIONS POSSIBLY AGGRAVATED BY EXPOSURE:
Diseases of the blood-forming organs, kidneys, nervous and possibly reproductive systems

POTENTIAL HEALTH EFFECTS:

EYE CONTACT: May cause moderate irritation, tearing, and reddening.
INHALATION: Inhalation of fumes or dust may cause local irritation to the respiratory system, dizziness, weakness, fatigue, nausea, and/or headache.
SKIN CONTACT: May cause mild skin irritation.
INGESTION: Harmful if swallowed. May cause irritation to the mouth, throat, and stomach. May cause abdominal discomfort, nausea, vomiting, and/or diarrhea.

POTENTIAL HEALTH EFFECTS (CHRONIC and OVEREXPOSURE)

Tin: Dust or fumes may cause irritation of the skin mucous membranes and may result in a benign Pneumoconiosis (Stannosis).
Silver: May cause discoloration of eyes and skin (Argyia).
Bismuth: May cause foul breath, a blue-black line on the gums, and Stomatitis.
Antimony: May cause gastrointestinal upset, sleeplessness, irritability, and muscular pain.

SECTION 2 NOTES:
SMT International, LLC does not recommend, manufacture, market, or endorse any of its products for human consumption.
SECTION 3: COMPOSITION/INFORMATION ON INGREDIENTS

<table>
<thead>
<tr>
<th>Hazardous Ingredients(1)</th>
<th>C.A.S. Number</th>
<th>Weight Percent</th>
<th>OSHA PEL mg/m³</th>
<th>ACGIH TLV TWA mg/m³</th>
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<tbody>
<tr>
<td>Modified Rosins(2)</td>
<td>NA</td>
<td>&lt;45</td>
<td>NE</td>
<td>NE</td>
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<tr>
<td>Mixed Carboxylic Acids(2)</td>
<td>NA</td>
<td>&lt;4</td>
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<tr>
<td>Tin 7440-31-5</td>
<td>2.00</td>
<td>2.00</td>
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<tr>
<td>Silver 7440-22-4</td>
<td>0.01</td>
<td>0.10</td>
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<tr>
<td>Bismuth 7440-69-9</td>
<td>NE</td>
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<tr>
<td>Antimony 7440-36-0</td>
<td>0.50</td>
<td>0.50</td>
<td></td>
<td></td>
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<tr>
<td>Copper 7440-50-8</td>
<td>1.00</td>
<td>1.00</td>
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</table>

Non-Hazardous Ingredients

| Surfactants              | N/A           | <4             | NE             | NE                  |
| Rheological Modifier     | N/A           | <5             | NE             | NE                  |

SECTION 3 NOTES:
(1) Per 29 CFR 1910 the mixture has not been tested as a whole. All hazardous components, which comprise 1% of the mixture (0.1% carcinogenic), are listed. Percentages of individual components are not listed as this information is considered a trade secret.
(2) The identity of the specific chemical(s) is being withheld as a trade secret per 29 CFR 1910.1200. The hazardous properties of these ingredients are disclosed in this SDS.

SECTION 4: FIRST AID MEASURES

EYES: Flush with water, contact a physician. Dust and/or fumes may cause irritation. If contact lenses can be removed easily, flush eyes without contact lenses. Seek medical attention if irritation persists.

SKIN: After handling material wash hands thoroughly with soap and water. Dust, vapor, and/or fumes are not readily absorbed through the skin. If irritation persists, obtain medical attention.

INGESTION: Seek medical attention immediately. Do not induce vomiting.

INHALATION: Remove to fresh air. If breathing is difficult, seek immediate medical attention.

SECTION 5: FIRE-FIGHTING MEASURES

EXTINGUISHING MEDIA: Use extinguishers appropriate for conditions.

SPECIAL FIRE FIGHTING PROCEDURES: Use NIOSH-approved self-contained Breathing Apparatus and full protective clothing if involved in a fire. Do not use water on fire where molten metal is present.

UNUSUAL FIRE AND EXPLOSION HAZARDS: Moderate in the form of dust when exposed to heat or flame.

SECTION 5 NOTES:
Molten solder alloys consisting of Antimony, Bismuth, Copper, Silver, and/or Tin do not produce significant quantities of fumes below 900 °F.

SECTION 6: ACCIDENTAL RELEASE MEASURES

PRECAUTIONS AND EQUIPMENT: Material is extremely thick and will not flow out.

ACCIDENTAL RELEASE MEASURES: If material spills or leaks use a spatula to collect spilled paste and place it in a plastic or glass jar. Remove traces of paste residue using cloth rags or paper towels moistened with Isopropyl Alcohol. Exposure to spilled material may be irritating. Follow on-site personal protective equipment recommendations.

SECTION 6 NOTES:
See Sections 2, 4, and 7 for additional information.

SECTION 7: HANDLING AND STORAGE

HANDLING: Keep containers tightly closed when not in use. Use care to avoid spills. Wear appropriate personal protective equipment when working with or handling solder paste. Always wash hands thoroughly after handling this product. Dispose of
following Federal, State/Provincial, and Local regulations.
SECTION 7: HANDLING AND STORAGE (continued)

STORAGE: Store product in tightly capped original containers in a cool, dry place. Keep away from food and drinking water. Keep away from heat and flames.

OTHER PRECAUTIONS: Empty containers may retain product residues in vapor, liquid, and/or solid form. All labeled hazard precautions should be observed.

SECTION 7 NOTES: For industrial use only.

SECTION 8: EXPOSURE CONTROLS/PERSONAL PROTECTION

ENGINEERING CONTROLS: Use only with production equipment designed for use with solder paste.

VENTILATION: Provide sufficient mechanical (general and/or local exhaust) ventilation to maintain exposure below TLVs.

RESPIRATORY PROTECTION: A NIOSH-approved air-purifying respirator with fume/organic chemical cartridge should be worn when airborne concentrations may be exceeded. General and local exhaust ventilation is the preferred means of protection.

EYE PROTECTION: Safety glasses are recommended to prevent contact with the eyes.

SKIN PROTECTION: Protective gloves should be worn when the possibility of skin contact exists.

PROTECTIVE CLOTHING OR EQUIPMENT: Remove contaminated clothes and launder before reuse.

WORK HYGIENIC PRACTICES: Cosmetics/Food/Drink/Tobacco should not be consumed or used in areas where solder products may be used. Always wash hands after handling soldering products and before applying or using cosmetics/food/drink/tobacco.

OTHER: Maintain eye wash stations in work areas. Avoid the use of contact lenses in high fume areas. Clean protective equipment regularly. Clean up spills immediately.

SECTION 9: PHYSICAL AND CHEMICAL PROPERTIES

APPEARANCE: Gray paste

ODOR: Odorless

ODOR THRESHOLD: Not established

pH as SUPPLIED: N/A

MELTING POINT: Varies

FREEZING POINT: Varies

INITIAL BOILING POINT: Varies

BOILING RANGE: N/A (°F/°C)

FLASH POINT: N/A (°F/°C)

EVAPORATION RATE: N/A

FLAMMABILITY (SOLID): Not established

UPPER/LOWER FLAMMABILITY: Not established

UPPER/Lower EXPLOSIVE LIMITS: Not established

VAPOR PRESSURE (mmHg): N/A (°F/°C)

VAPOR DENSITY (AIR = 1): N/A (°F/°C)

RELATIVE DENSITY: Not established

SOLUBILITY IN WATER: Insoluble

PARTITION COEFFICIENT (n-octanol/water): Not established

AUTOIGNITION TEMPERATURE: Not established

DECOMPOSITION TEMPERATURE: Not established

VISCOSITY:

SECTION 9 NOTES: Other physical and chemical properties depend on alloy composition.

Some typical alloy compositions are:

96.5%Tin/3%Silver/0.5%Copper
99.3%Tin/0.7%Copper
95%Tin/5%Antimony
95.5%Tin/4.0%Silver/0.5%Copper
42%Tin/58%Bismuth

SECTION 10: STABILITY AND REACTIVITY

STABILITY: Stable

CONDITIONS TO AVOID (STABILITY): Not established

INCOMPATIBILITY (MATERIAL TO AVOID): Oxidizing materials, acids, hydrogen peroxide, bases

HAZARDOUS DECOMPOSITION/BY-PRODUCTS: N/A

POSSIBILITY OF HAZARDOUS REACTIONS: Will not occur
SECTION 11: TOXICOLOGICAL INFORMATION

ACUTE TOXICITY:

<table>
<thead>
<tr>
<th>Compounds</th>
<th>LD50</th>
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<tbody>
<tr>
<td>Antimony</td>
<td>7000 mg/kg</td>
</tr>
<tr>
<td>Silver</td>
<td>100/mg/kg</td>
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</table>

SKIN CORRISION/IRRITATION: Not established
SERIOUS EYE DAMAGE/IRRITATION: Not available
GERM CELL MUTAGENICITY: Not available
CARCINOGENICITY:

| OSHA: N/A | ACGIH: Lead (Pb)-A3 | NTP: N/A | IARC: Lead (Pb)-Group 2B |

REPRODUCTIVE TOXICITY: Not available
STOT-SINGLE EXPOSURE: Not available
STOT-REPEATED EXPOSURE: Not available
ASPIRATION HAZARD: Not available

SECTION 11 NOTES:
This product is a solid that has not been tested as a whole to determine its hazards. Synergistic or additive effects of the above chemicals are unknown, as are the effects of exposure to these chemicals in addition to others present in the work place. See Section 2 for additional health hazards.

SECTION 12: ECOLOGICAL INFORMATION

| TOXICITY: Not established |
| PERSISTENCE AND DEGRADABILITY: Not established |
| BIOACUMULATIVE POTENTIAL: Not established |
| MOBILITY IN SOIL: Not established |
| OTHER ADVERSE EFFECTS: Not established |

SECTION 13: DISPOSAL CONSIDERATIONS

WASTE DISPOSAL METHOD: Scrap and waste solder products should be recycled or stored in a dry, sealed container for later disposal. Disposal must be in accordance with standards, regulations, laws, and statutes set forth by Federal, State/Provincial, and Local Regulations.

SECTION 14: TRANSPORT INFORMATION

Transport in accordance with applicable regulations and requirements.

UN Number: Not available
UN Proper Shipping Name: Not available
Packaging Group: Not applicable
Environmental Hazards: None

TRANSPORT HAZARD CLASSES:
US DOT Hazardous Material Classification: Solder Paste is not listed as a DOT hazardous material
Water Transportation: Solder Paste is not listed as a hazardous material IATA
Hazardous Material Classification: Solder Paste is not listed as IATA hazardous material

SECTION 15: REGULATORY INFORMATION

All ingredients are listed on the EPA TSCA Inventory. Finished product is not listed on the EPA TSCA Inventory.

U.S. FEDERAL REGULATIONS: None
STATE REGULATIONS: None
INTERNATIONAL REGULATIONS: None
SECTION 16: OTHER INFORMATION

This SDS is a compilation of information supplied by the manufacturers of the chemicals contained in this product.

<table>
<thead>
<tr>
<th>HMIS Rating</th>
<th>Health</th>
<th>Flammability</th>
<th>Physical Hazard</th>
<th>Personal Protection</th>
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<tr>
<td></td>
<td>1</td>
<td>1</td>
<td>0</td>
<td>X</td>
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PREPARATION INFORMATION:
This update supersedes all previously released documents.

KEY:
N/A: Not applicable
GHS: Global Harmonized System
OSHA: Occupational Safety and Health Administration
ACGIH: American Conference of Governmental Industrial Hygienists
NTP: National Toxicology Program
IARC: International Agency for Research on Cancer
CAS: Chemical Abstract Service
PEL: Permissible Exposure Limit
TLV: Threshold limit value
TWA: Time Weighted Average
NE: Not Established
NIOSH: National Institute for Occupational Safety and Health
LD50: Lethal Dose, 50% or median lethal dose
STOT: Specific target organ toxicity
US DOT: United States Department of Transportation
DOT: Department of Transportation
IATA: International Air Transport Association
EPA: Environmental Protection Agency
TSCA: Toxic Substance Control Act
HMIS: Hazardous Material Identification System

Prepared By: Wendy W. Gesick
Approved By: Leigh W. Gesick

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